

PHOTOCOUPLER **PS2811-1**, **PS2811-4**

LOW INPUT CURRENT, HIGH CTR 4, 16-PIN SSOP PHOTOCOUPLER

-NEPOC Series-

DESCRIPTION

The PS2811-1 and PS2811-4 are optically coupled isolators containing a GaAs light emitting diode and an NPN silicon phototransistor in a plastic SSOP for high density applications.

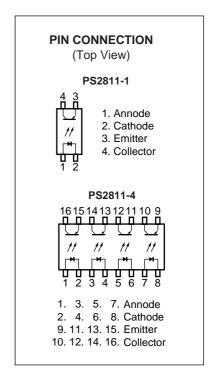
The package is a Small SOP (Small Outline Package) type for high density mounting applications.

FEATURES

- High current transfer ratio (CTR = 200% TYP. @ $I_F = \pm 1$ mA)
- High isolation voltage (BV = 2 500 Vr.m.s.)
- Small and thin package (4, 16-pin SSOP, Pin pitch 1.27 mm)
- Ordering number of tape product: PS2811-1-F3, F4, PS2811-4-F3, F4
- ★ Pb-free product
- ★ Safety standards: PS2811-1, -4
 - UL approved: File No. E72422
 - DIN EN60747-5-2 (VDE0884 Part2) approved (Option)

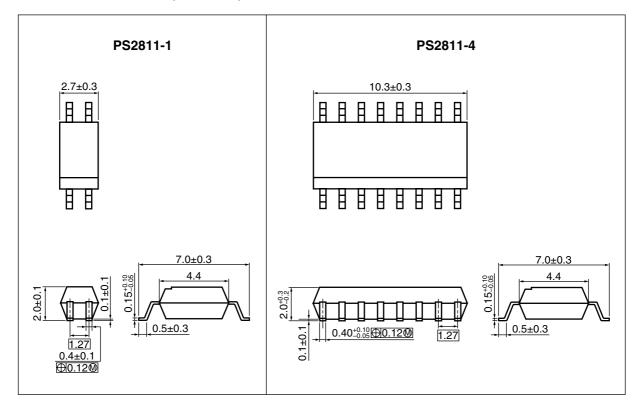
APPLICATIONS

- Programmable logic controllers
- · Small power supply
- Hybrid IC
- Modem/FAX

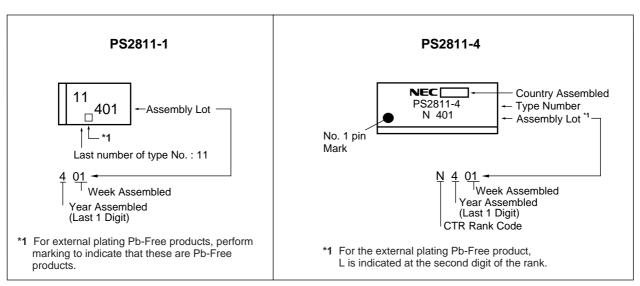


The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version.

PACKAGE DIMENSIONS (UNIT: mm)



★ MARKING EXAMPLE



★ ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number *1
PS2811-1	PS2811-1	Solder	50 pcs (Tape 50 pcs cut)	Standard products	PS2811-1
PS2811-1-F3	PS2811-1-F3	contains lead	Embossed Tape 3 500 pcs/reel	(UL approved)	
PS2811-1-F4	PS2811-1-F4				
PS2811-1-V	PS2811-1-V		50 pcs (Tape 50 pcs cut)	DIN EN60747-5-2	
PS2811-1-V-F3	PS2811-1-V-F3		Embossed Tape 3 500 pcs/reel	(VDE0884 Part2)	
PS2811-1-V-F4	PS2811-1-V-F4			Approved (Option)	
PS2811-4	PS2811-4		Magazine Case 45 pcs	Standard products	PS2811-4
PS2811-4-F3	PS2811-4-F3		Embossed Tape 2 500 pcs/reel	(UL approved)	
PS2811-4-F4	PS2811-4-F4				
PS2811-4-V	PS2811-4-V		Magazine Case 45 pcs	DIN EN60747-5-2	
PS2811-4-V-F3	PS2811-4-V-F3		Embossed Tape 2 500 pcs/reel	(VDE0884 Part2)	
PS2811-4-V-F4	PS2811-4-V-F4			Approved (Option)	
PS2811-1	PS2811-1-A	Pb-Free	50 pcs (Tape 50 pcs cut)	Standard products	PS2811-1
PS2811-1-F3	PS2811-1-F3-A		Embossed Tape 3 500 pcs/reel	(UL approved)	
PS2811-1-F4	PS2811-1-F4-A				
PS2811-1-V	PS2811-1-V-A		50 pcs (Tape 50 pcs cut)	DIN EN60747-5-2	
PS2811-1-V-F3	PS2811-1-V-F3-A		Embossed Tape 3 500 pcs/reel	(VDE0884 Part2)	
PS2811-1-V-F4	PS2811-1-V-F4-A			Approved (Option)	
PS2811-4	PS2811-4-A		Magazine Case 45 pcs	Standard products	PS2811-4
PS2811-4-F3	PS2811-4-F3-A		Embossed Tape 2 500 pcs/reel	(UL approved)	
PS2811-4-F4	PS2811-4-F4-A				
PS2811-4-V	PS2811-4-V-A		Magazine Case 45 pcs	DIN EN60747-5-2	
PS2811-4-V-F3	PS2811-4-V-F3-A		Embossed Tape 2 500 pcs/reel	(VDE0884 Part2)	
PS2811-4-V-F4	PS2811-4-V-F4-A			Approved (Option)	

^{*1} For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS (Unless otherwise specified, TA = 25°C)

Parameter		Symbol	Ratings		
			PS2811-1	PS2811-4	Unit
Diode	Forward Current (DC)	lF	50		mA
	Reverse Voltage	VR	6		V
	Power Dissipation Derating	⊿P₀/°C	0.6	0.7	mW/°C
	Power Dissipation	Po	60	70	mW/ch
	Peak Forward Current*1	IFP	1	1.0	
Transistor	Collector to Emitter Voltage	VCEO	4	.0	V
	Emitter to Collector Voltage	VECO		5	V
	Collector Current	lc	4	.0	mA/ch
	Power Dissipation Derating	⊿Pc/°C	1	.2	mW/°C
	Power Dissipation	Pc	1:	20	mW/ch
Isolation Voltage*2		BV	2 500		Vr.m.s.
Operating Ambient Temperature		TA	−55 to +100		°C
Storage Temperature		Tstg	-55 to +150		°C

^{*1} PW = 100 μs, Duty Cycle = 1%

^{*2} AC voltage for 1 minute at $T_A = 25$ °C, RH = 60% between input and output.

Pins 1-2 shorted together, 3-4 shorted together (PS2811-1).

Pins 1-8 shorted together, 9-16 shorted together (PS2811-4).

ELECTRICAL CHARACTERISTICS (TA = 25°C)

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	VF	I _F = 5 mA		1.15	1.4	V
	Reverse Current	lR	VR = 5 V			5	μA
	Terminal Capacitance	Ct	V = 0 V, f = 1 MHz		15		pF
Transistor	Collector to Emitter Dark Current	ICEO	IF = 0 mA, VcE = 40 V			100	nA
Coupled	Current Transfer Ratio	CTR	IF = 1 mA, VcE = 5 V	100	200	400	%
	Collector Saturation Voltage	VCE (sat)	I _F = 1 mA, I _C = 0.2 mA			0.3	V
	Isolation Resistance	R _I -o	Vi-o = 1 kVDC	10 ¹¹			Ω
	Isolation Capacitance	C _{I-O}	V = 0 V, f = 1 MHz		0.4		pF
	Rise Time*2	tr	$Vcc = 5 \text{ V}, \text{ Ic} = 2 \text{ mA}, \text{ RL} = 100 \Omega$		4		μS
	Fall Time*2	t _f			5		

*1 CTR rank

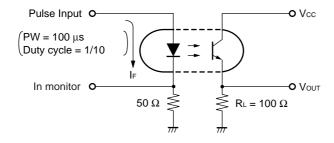
PS2811-1

N: 100 to 400 (%) K: 200 to 400 (%) L: 150 to 300 (%) M: 100 to 200 (%)

PS2811-4

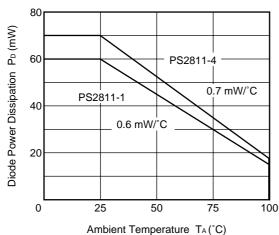
N: 100 to 400 (%)

*2 Test circuit for switching time

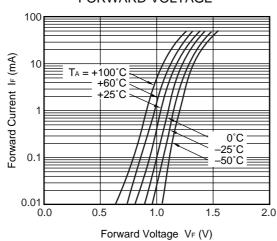


TYPICAL CHARACTERISTICS (Unless otherwise specified, TA = 25°C)

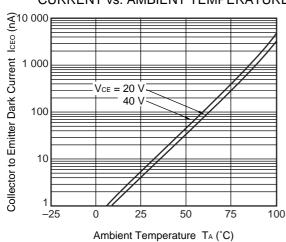




FORWARD CURRENT vs. FORWARD VOLTAGE

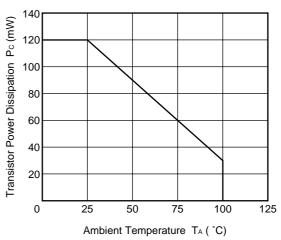


COLLECTOR TO EMITTER DARK **CURRENT vs. AMBIENT TEMPERATURE**

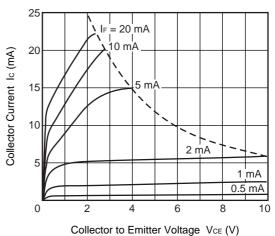


Remark The graphs indicate nominal characteristics.

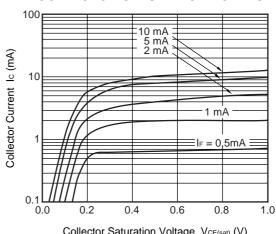
TRANSISTOR POWER DISSIPATION vs. AMBIENT TEMPERATURE



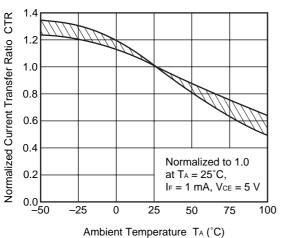
COLLECTOR CURRENT vs. **COLLECTOR TO EMITTER VOLTAGE**



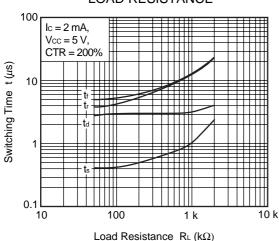
COLLECTOR CURRENT vs. **COLLECTOR SATURATION VOLTAGE**



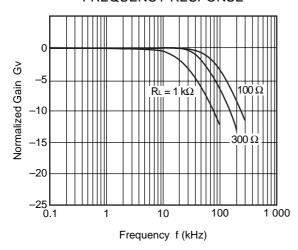
NORMALIZED CURRENT TRANSFER RATIO vs. AMBIENT TEMPERATURE



SWITCHING TIME vs. LOAD RESISTANCE

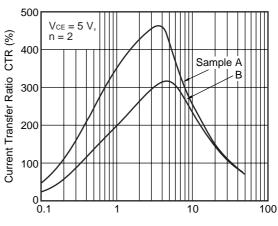


FREQUENCY RESPONSE



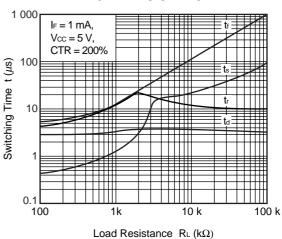
Remark The graphs indicate nominal characteristics.

CURRENT TRANSFER RATIO vs. FORWARD CURRENT

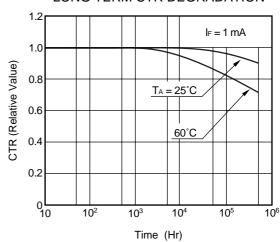


Forward Current IF (mA)

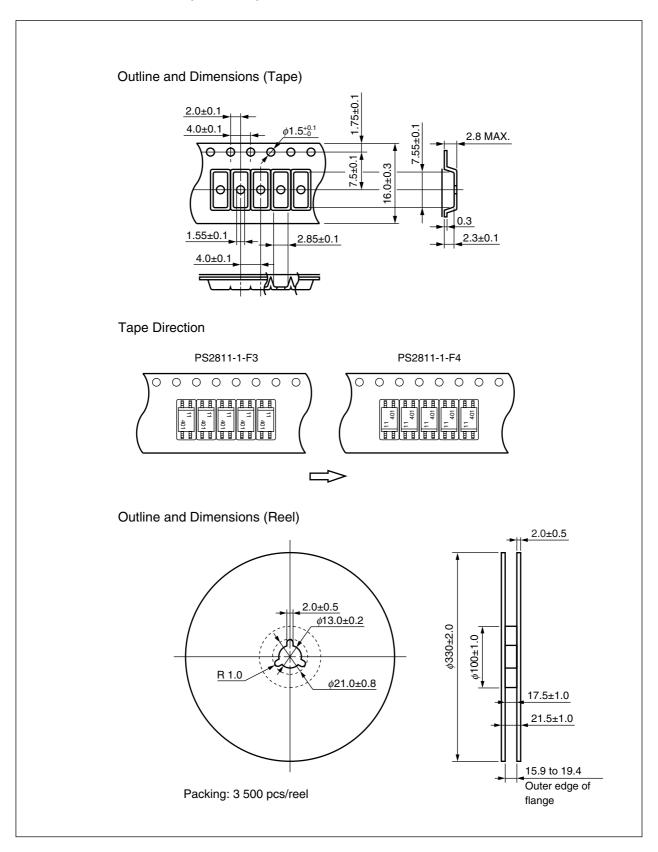
SWITCHING TIME vs. LOAD RESISTANCE

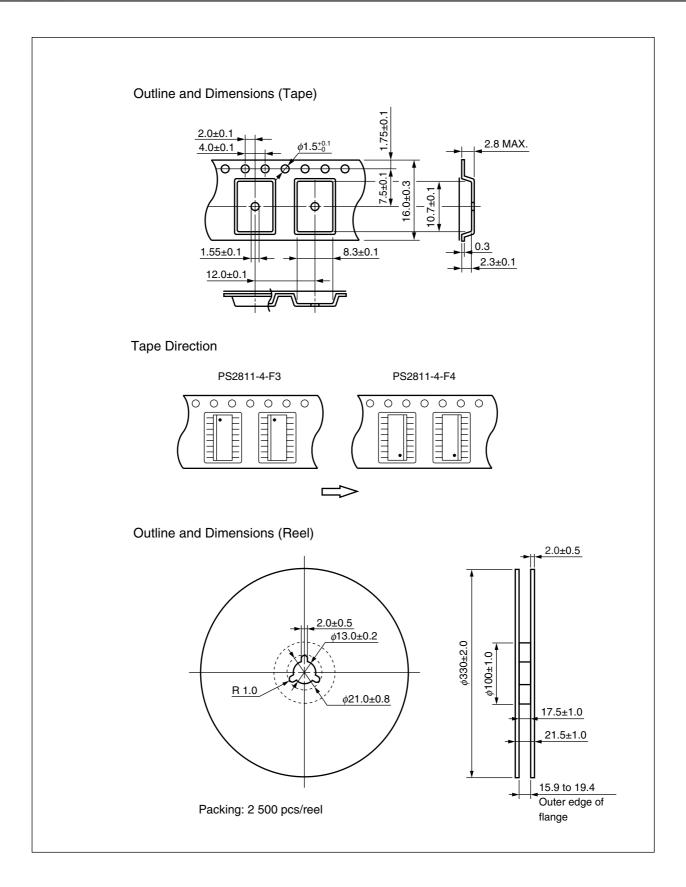


LONG TERM CTR DEGRADATION



TAPING SPECIFICATIONS (UNIT: mm)





NOTES ON HANDLING

1. Recommended soldering conditions

(1) Infrared reflow soldering

• Peak reflow temperature 260°C or below (package surface temperature)

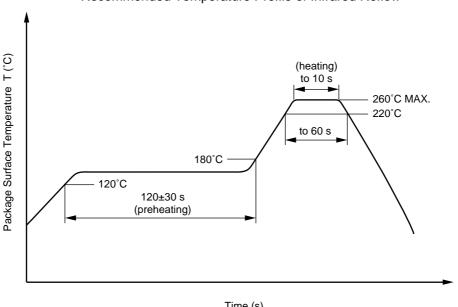
• Time of peak reflow temperature 10 seconds or less 60 seconds or less • Time of temperature higher than 220°C

• Time to preheat temperature from 120 to 180°C 120±30 s · Number of reflows Three

• Flux Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



Time (s)

(2) Wave soldering

• Temperature 260°C or below (molten solder temperature)

• Time 10 seconds or less

· Preheating conditions 120°C or below (package surface temperature)

· Number of times One (Allowed to be dipped in solder including plastic mold portion.)

• Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine

content of 0.2 Wt% is recommended.)

(3) Soldering by Soldering Iron

• Peak Temperature (lead part temperature) 350°C or below • Time (each pins) 3 seconds or less

• Flux Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

(a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead

(b) Please be sure that the temperature of the package would not be heated over 100°C

(4) Cautions

• Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between collector-emitters at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

USAGE CAUTIONS

- 1. Protect against static electricity when handling.
- 2. Avoid storage at a high temperature and high humidity.



4590 Patrick Henry Drive Santa Clara, CA 95054-1817 Telephone: (408) 919-2500

Facsimile: (408) 988-0279

Subject: Compliance with EU Directives

CEL certifies, to its knowledge, that semiconductor and laser products detailed below are compliant with the requirements of European Union (EU) Directive 2002/95/EC Restriction on Use of Hazardous Substances in electrical and electronic equipment (RoHS) and the requirements of EU Directive 2003/11/EC Restriction on Penta and Octa BDE.

CEL Pb-free products have the same base part number with a suffix added. The suffix –A indicates that the device is Pb-free. The -AZ suffix is used to designate devices containing Pb which are exempted from the requirement of RoHS directive (*). In all cases the devices have Pb-free terminals. All devices with these suffixes meet the requirements of the RoHS directive.

This status is based on CEL's understanding of the EU Directives and knowledge of the materials that go into its products as of the date of disclosure of this information.

Restricted Substance per RoHS	Concentration Limit per RoHS (values are not yet fixed)		Concentration contained in CEL devices		
Lead (Pb)	< 1000 PPM	-A Not Detected	-AZ (*)		
Mercury	< 1000 PPM	Not Detected			
Cadmium	< 100 PPM	Not Detected			
Hexavalent Chromium	< 1000 PPM	Not Detected			
PBB	< 1000 PPM	Not Detected			
PBDE < 1000 PPM		Not Detected			

If you should have any additional questions regarding our devices and compliance to environmental standards, please do not hesitate to contact your local representative.

Important Information and Disclaimer: Information provided by CEL on its website or in other communications concerting the substance content of its products represents knowledge and belief as of the date that it is provided. CEL bases its knowledge and belief on information provided by third parties and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. CEL has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. CEL and CEL suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall CEL's liability arising out of such information exceed the total purchase price of the CEL part(s) at issue sold by CEL to customer on an annual basis.

See CEL Terms and Conditions for additional clarification of warranties and liability.